## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor

: Seiji FUNABA, et al.

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## **PRIORITY CLAIM AND**

## **SUBMISSION OF PRIORITY DOCUMENT**

SIR:

Applicant hereby claims priority under 35 USC 119 from **Japanese** patent application number 318271/2002 filed **October 31, 2002,** a copy of which will follow.

Respectfully submitted,

Michael I. Markowitz

Reg. No. 30,659

Katten Muchin Zavis Rosenman 575 Madison Avenue New York, NY 10022-2585 (212) 940-8800

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